506965808 11/08/2021

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7012646

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
JHON-JHY LIAW	10/08/2019

## **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.	
Street Address:	NO. 8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	300-78	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17521389

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	DANIEL R. MCCLURE
SIGNATURE:	/Daniel R. McClure/
DATE SIGNED:	11/08/2021

**Total Attachments: 1** 

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**PATENT** REEL: 058049 FRAME: 0562 506965808

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# ASSIGNMENT

WHEREAS, Jhon-Jhy LIAW			
hereafter referred to as ASSIGNOR, has/described and set forth in the below identif	have invented certain new and useful improvements as ied application for United States Letters Patent:		
Title: SEMICONDUCTOR STRUCTURE WITH DIELECTRIC FIN IN MEMORY CELL			
AND METHOD FOR FORMING THE SAME			
Filed: 2019-10-01 Executed on:	Serial No. <u>16/589,273</u>		
WHEREAS, Taiwan Semiconductor Man	ufacturing Co., Ltd., of No. 8, Li-Hsin Rd. 6, Hsinchu		
	O.C., hereinafter referred to as ASSIGNEE, is desirous		
	said invention and application and in any U.S. Letters		
Patent which may be granted on the same;	•		
valuable consideration, receipt of which is sold, assigned and transferred, and by thes Assignee, and Assignee's successors and a the said invention and application and all Patent which may hereafter be granted on the and enjoyed by said Assignee as fully and said Assignor had this Assignment and tr	M IT MAY CONCERN: Be it known that, for good and a hereby acknowledged by Assignor, Assignor has/have e presents does/do sell, assign and transfer unto the said assigns, all his/her/their rights, title and interest in and to future improvements thereon, and in and to any Letters the same in the United States, the said interest to be held exclusively as it would have been held and enjoyed by ansfer not been made, to the full end and term of any on, or of any division, renewal, continuation in whole or colongation or extension thereof.		
applications, execute, verify, acknowled applications for Letters Patent and for the transfer thereof, and will perform such of	Assignee in the prosecution of said application and/or lige and deliver all such further papers, including the reissue thereof, and instruments of assignment and the acts as Assignee lawfully may request, to obtain or and improvement, and to year title thereto is not an and improvement, and to year title thereto is not an and improvement.		

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Date

Name: Thon-Thy LIAW

P20183522US00/0503-B35415-US

**RECORDED: 11/08/2021** 

Assignee, or Assignee's successors and assigns.

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